GP2L09/GP2L24 GP2L26

■ Features

1. Compact and thin

GP2L09: Compact DIP, long lead type

GP2L24: Compact DIP type **GP2L26**: Flat lead type

2. Optimum detection distance: 0.6 to 0.8mm

3. High sensitivity

(I_C : MIN. 0.5mA at I_F = 4mA)

4. Visible light cut-off type

■ Applications

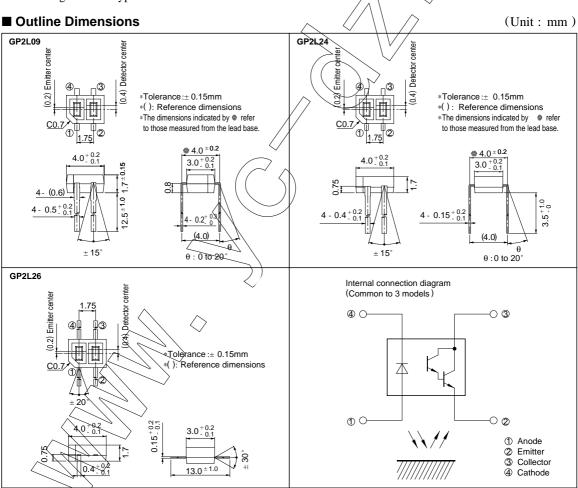
1. Cassette tape recorders, VCRs

Photointerrupter

2. Floppy disk drives

3. Various microcomputerized control equipment

Subminiature, High Sensitivity



■ Absolute Maximum Ratings

$(T_0 -$	25°	C)
(1a-	23	-

	Parameter	Symbol	Rating	Unit
	Forward current	I_F	50	mA
Input	Reverse voltage	V_R	6	V
	Power dissipation	P	75	mW
	Collector-emitter voltage	V_{CEO}	35	V
0	Emitter-collector voltage	V_{ECO}	6	V
Output	Collector current	Ic	50	mA
	Collector power dissipation	Pc	75	mW /
Total power dissipation		P _{tot}	100	mW
Operating temperature		Topr	- 25 to + 85	°C \
Storage temperature		T stg	- 40 to + 100	°C
	*1Soldering temperature	T sol	260	°C

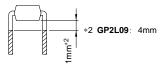
^{*1} Within 5 seconds (Soldering areas for each model are shown below.)

GP2L09, GP2L24

Soldering area

The hatched area more than 1mm*2 away from the lower edge of package as shown in the drawing

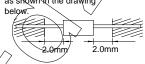
below.





Soldering area The hatched area more than 2.0mm away from

the both edge of package as shown in the drawing



■ Electro-optical Characteristics

(Ta=	= 25°	$^{\circ}C$

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage		/I _F	$\langle 1_{\bar{i}} = 20 \text{mA} \rangle$	-	1.2	1.4	V
	Reverse current		IR	$V_R = 6V$	-	-	10	μΑ
Output	Collector dark curren	t ^	ICEQ	$V_{CE} = 10V, I_{F} = 0$	-	-	1x 10 - 6	A
	*3Collector current		Ic	$V_{CE} = 2V$, $I_F = 4mA$	0.5	3.0	15.0	mA
Transfer- charac- teristics	Response time Rise time Fall time	Rise-time	14	$V_{CE} = 2V, I_{C} = 10mA$	-	80	400	μs
		$t_{\rm f}$	$R_L = 100\Omega$, $d = 1mm$	-	70	400	μs	
	*4Leak current		ILEAK	$I_F = 4mA$, $V_{CE} = 5V$	-	-	5.0	μΑ

^{*3} The condition and arrangement of the reflective object are shown in the right drawing.

The ranking of collector current shall be classified into the following 6 ranks.

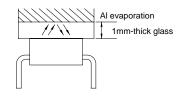
(GP2L09, GP2L24, GP2L26)

Rank	Collector current Ic (mA)
*5A	0.5 to 1.9
В	1.45 to 5.4
С	4.040 (5.0
A or B	0.5 to 5.4
B or C	1.45 to 15.0
A, B og/C	0.5 to 15.0

^{*5} GP2L24 and GP2L26 don't

have A rank.

Test Condition for Collector Current



^{*4} Without reflective object

Fig. 1 Forward Current vs.

Ambient Temperature

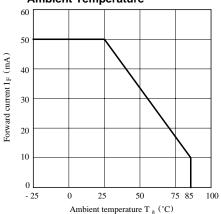


Fig. 3 Peak Forward Current vs. Duty Ratio

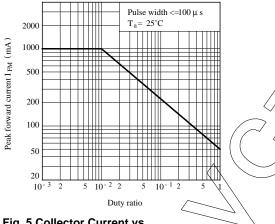


Fig. 5 Collector Current vs. Forward Current

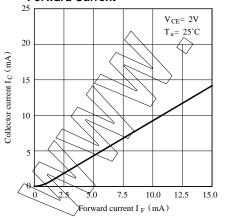


Fig. 2 Power Dissipation vs.
Ambient Temperature

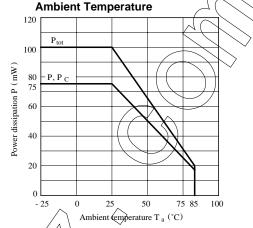


Fig. 4 Forward Current vs.
Forward Voltage

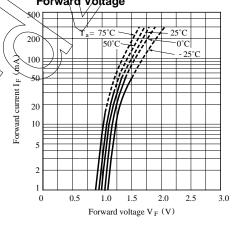


Fig. 6 Collector Current vs.

Collector-emitter Voltage

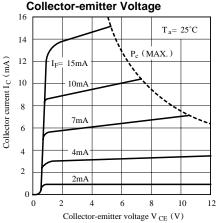


Fig. 7 Relative Collector Current vs. **Ambient Temperature**

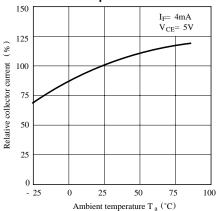
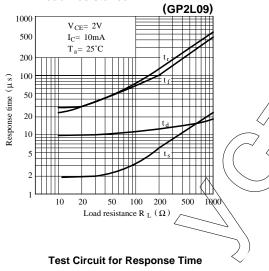


Fig. 9-a Response Time vs. **Load Resistance**



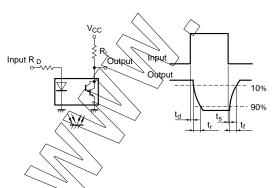


Fig. 8 Collector Dark Current vs. Ambient Temperature 10 $V_{CE} = 10V$ 10 Collector dark current I_{CEO} (A) 10 - 6 10 - 7 10 -10 10 - 10 10 - 25 25 50 75 100 Ambient temperature Ta (°C)

Fig. 9-b Response Time vs.

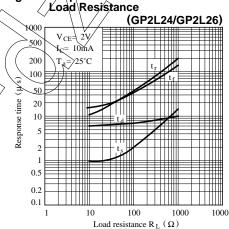
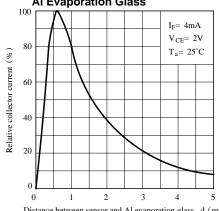
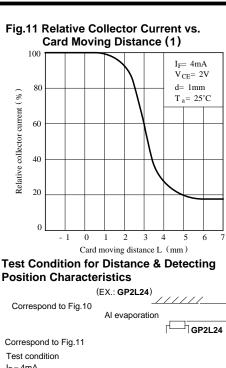
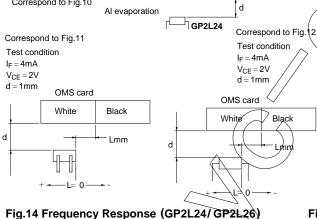


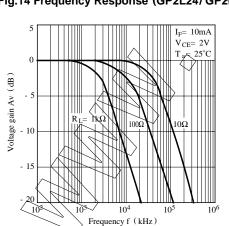
Fig.10 Relative Collector Current vs. Distance between Sensor and Al Evaporation Glass

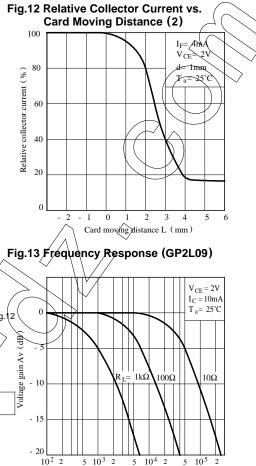


Distance between sensor and Al evaporation glass d (mm)



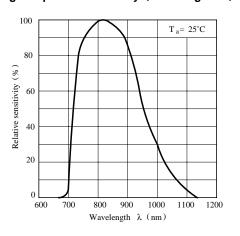








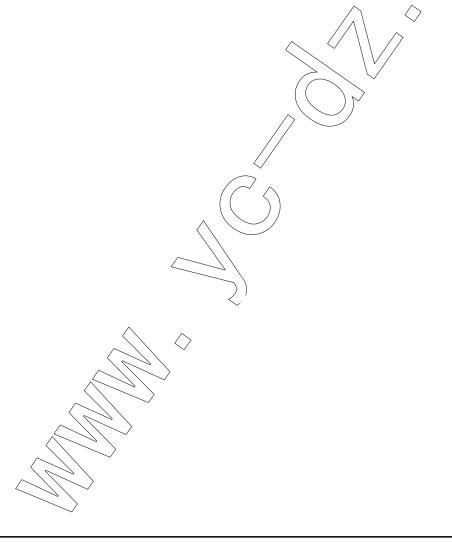
Frequency f (Hz)



■ Precautions for Use

- (1) In order to stabilize power supply line, connect a by-pass capacitor of more than 0.01 μ F between Vcc and GND near the device.
- (2) In this product, the PWB is fixed with a resin cover, and cleaning solvent may remain inside the case; therefore, dip cleaning or ultrasonic cleaning are prohibited.
- (3) Remove dust or stains, using an air blower or a soft cloth moistened in cleaning solvent. However, do not perform the above cleaning using a soft cloth with cleaning solvent in the marking portion.
 - In this case, use only the following type of cleaning solvent used for wiping off:

 Ethyl alcohol, Methyl alcohol, Isopropyl alcohol, Freon TE, Freon TF, Diflon solvent S3-E
 When the cleaning solvents except for specified materials are used, please consult us.
- (4) As for other general cautions, refer to the chapter "Precautions for Use".



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